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New 6U VITA 66/67 Hybrid Development Chassis From Pixus Technologies

Waterloo, Ontario — May 23, 2019 – Pixus Technologies, a provider of embedded computing and enclosure solutions, now offers a 6U OpenVPX chassis platform with a mix of VITA 66.4 optical connectors and VITA 67.3 RF connectors.

The open frame chassis features a 6-slot 6U OpenVPX backplane with the RF and optical connector cutouts. The specialty connectors can optionally be installed by Pixus. The OpenVPX connectors are pass-through for versatility in development. The backplane can be loaded to various requirements, with slots positions populated/unpopulated as needed. There are 3U versions also available.

The chassis includes a modular power supply for up to 6 VPX voltages. Card guides that accepted conduction-cooled boards are optional. Contact Pixus for C4ISR Modular Open Suite of Standards (CMOSS) and Sensor Open Standard Architecture (SOSA) options.

Pixus offers backplanes, chassis platforms, and specialty products in various modular open standard architectures. The company provides enclosure solutions in 19” rackmount, ATR/ Rugged, development, and specialty small form factor designs.

About Pixus Technologies

Leveraging over 20 years of innovative standard products, the Pixus team is comprised of industry experts in electronics packaging. Founded in 2009 by senior management from Kaparel Corporation, a Rittal company, Pixus Technologies' embedded backplanes and systems are focused primarily on ATCA, OpenVPX, MicroTCA, and custom designs. Pixus also has an extensive offering of VME-based and cPCI-based solutions. In May 2011, Pixus Technologies became the sole authorized North and South American supplier of the electronic packaging products previously offered by Kaparel Corporation and Rittal.